



ESTC 2010 in Berlin

Electronics System Integration Technologies Conference
September 13 – 16, 2010, Maritim Pro Arte

Call for Papers

Join us in Berlin for the third Electronics System Integration Technology Conference!

ESTC 2010 is the global event that brings together key researchers, innovators, decision-makers, technologists, businesses, and professional associations working in microelectronic packaging.

Organized by IEEE-CPMT since 2006, the conference series is the premier venue for academics and industry to present, demonstrate, and discuss the latest developments in assembly and interconnection technology and new innovative applications. It is most of all a biannual opportunity for the international community to discuss and debate the state and the evolution of packaging technologies.

Just like its highly successful predecessor events in Dresden (2006) and Greenwich (2008) ESTC 2010 will again feature a powerful technical program, as well as professional short courses on various microelectronic packaging technologies. The concurrent exhibition will facilitate the presentation of state-of-the-art technological services and equipment to an interested audience of international decision-makers from science and industry.

Call for Papers

ESTC 2010 seeks original papers describing research in all areas of electronic packaging. Paper abstracts may be submitted to the following tracks:

- Advanced packaging
- Microsystem packaging
- New materials and processes
- Optoelectronics
- Assembly and manufacturing technology
- Modelling and simulation
- Applied reliability
- Power electronics
- Electrical design and modelling
- Emerging technologies

More detailed information on the individual tracks can be found at www.estc-2010.de.

Please indicate up to two major topics as listed above that your paper should be assigned to.

Paper Submission

You are invited to submit a 300-500 word abstract that describes the scope, content and key points of your proposed paper. Abstracts must include results and graphics. Please visit www.estc-2010.de to upload your abstract. Submission of proposals for poster presentations is also welcome. Poster authors will have the opportunity to present their posters during a special poster session and over the course of the conference. The official language of all presentations is English.

All oral and poster presentation papers will be included in the conference proceedings.

The abstract must be received by February 1, 2010. Your submission must include the mailing address, business telephone number and email address of the presenting author and affiliations of all authors.

All submitted abstracts will be reviewed by the committee to ensure a high-quality conference. Authors will be notified of paper acceptance with instructions for publication by April 1, 2010. At the discretion of the program committee, paper abstracts submitted may be considered for poster presentation.

Manuscripts are due in final form for publication in the Conference Proceedings by June 1, 2010. The work should be original and not previously published, and avoid inclusion of commercial content.

Additional instructions about formatting the paper will be published on www.estc-2010.de.

Best Presentation Award and Best Poster Award:

ESTC will select the best paper presentation. The author(s) will receive a personalized ESTC award and share a check for EUR 1,000,-.

ESTC will select the best poster whose author(s) will receive a personalized ESTC award and share a check for EUR 1,000,-.

Important Dates:

- **Submission deadline for abstracts: February 1, 2010**
- **Notification of paper acceptance: April 1, 2010**
- **Final paper due: June 1, 2010**

We look forward to welcoming you to the third IEEE-CPMT Electronics Systems Integration Conference ESTC 2010 in Berlin!



Rolf Aschenbrenner
General Chair for ESTC 2010



Dr. Klaus-Dieter Lang
Executive Chair for ESTC 2010



Eric Beyne
Programme Chair for ESTC 2010